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AF 24W

PATENT  
450100-03654

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant : Katsuhiro DOI et al.  
Serial No. : 09/996,518  
For : MOLDING DIE APPARATUS AND MOLDING METHOD  
Filed : November 29, 2001  
Examiner : Luk, Emmanuel S.  
Art Unit : 1722

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**RESPONSE UNDER 37 C.F.R. § 1.116**

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Sir:

Responsive to the Final Official Action mailed April 20, 2005, please amend the above-identified application as follows: